

SW25-4G

TO-218, TO-220, TO-220-single gauge (0.020"), TO-247, Board Level



Extruded heat sink with large radial fins and device clips

This non-electronic component is functionally unaffected by the normal soldering or reflow processes used for semiconductor circuits. The heat resistance time or heat resistance temperature is not applicable for the component.

Height: 24.89
 Mount Orientation: Vertical
 Finish: Black Anodize
 Board Mounting: Pins
 RoHS: compliant

Thermal Resistance: 11.40

Additional Drawing Dimensions: A: 25

